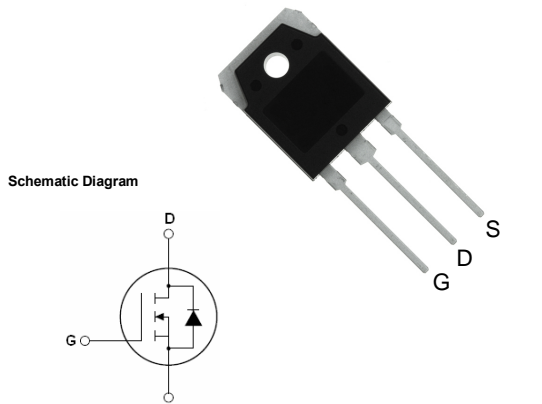
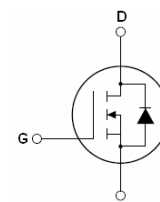


Pb Free Plating Product

2SK4107



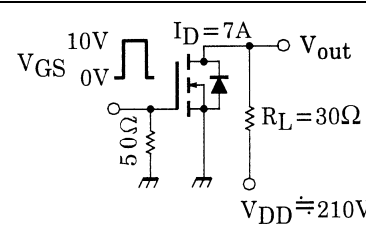
THINKISEMI 15A,500V N-CHANNEL PLANAR STRIPE POWER MOSFETs

<p>Features</p> <ul style="list-style-type: none"> ※ Low ON Resistance ※ Low Gate Charge ※ Peak Current vs Pulse Width Curve ※ ESD Capability Improved ※ 100% Avalanche Tested <p>Application</p> <ul style="list-style-type: none"> ※ Uninterruptible Power Supply(UPS) ※ LCD Panel Power ※ DC-AC Inverter, Amplifier and SMPS <p>Mechanical Data</p> <ul style="list-style-type: none"> ※ Case: TO-3P non-isolated package ※ Epoxy: UL 94V-0 rate flame retardant ※ Terminals: Solderable per MIL-STD-202 method 208 ※ Polarity: As per configuration ※ Mounting position: Any ※ Weight: 6.0 gram approximately 	<p>TO-3P pkg outline & internal configuration</p>  <p>Schematic Diagram</p> 
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Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Drain-source voltage	V_{DSS}	500	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	500	V	
Gate-source voltage	V_{GSS}	± 30	V	
Drain current	DC (Note 1)	I_D	15	A
	Pulse (Note 1)	I_{DP}	60	A
Drain power dissipation ($T_c = 25^\circ\text{C}$)	P_D	150	W	
Single-pulse avalanche energy (Note 2)	E_{AS}	765	mJ	
Avalanche current	I_{AR}	15	A	
Repetitive avalanche energy (Note 3)	E_{AR}	15	mJ	
Channel temperature	T_{ch}	150	$^\circ\text{C}$	
Storage temperature range	T_{stg}	-55~150	$^\circ\text{C}$	

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 10	μA
Gate-source breakdown voltage		$V_{(BR)GSS}$	$I_G = \pm 10\ \mu\text{A}, V_{DS} = 0\text{ V}$	± 30	—	—	V
Drain cutoff current		I_{DSS}	$V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	μA
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	500	—	—	V
Gate threshold voltage		V_{th}	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 7.0\text{ A}$	—	0.33	0.4	Ω
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 7.0\text{ A}$	4.0	8.5	—	S
Input capacitance		C_{iss}	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	2450	—	pF
Reverse transfer capacitance		C_{rss}		—	15	—	
Output capacitance		C_{oss}		—	220	—	
Switching time	Rise time	t_r		—	50	—	ns
	Turn-on time	t_{on}		—	90	—	
	Fall time	t_f		—	45	—	
	Turn-off time	t_{off}		—	175	—	
Total gate charge (gate-source plus gate-drain)		Q_g	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 15\text{ A}$	—	48	—	nC
Gate-source charge		Q_{gs}		—	26	—	
Gate-drain ("Miller") charge		Q_{gd}		—	22	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	15	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	60	A
Forward voltage (diode)	V_{DSF}	$I_{DR} = 15\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	t_{rr}	$I_{DR} = 15\text{ A}, V_{GS} = 0\text{ V}$ $dI_{DR} / dt = 100\text{ A} / \mu\text{s}$	—	1050	—	ns
Reverse recovery charge	Q_{rr}		—	13	—	μC

Thermal Characteristics

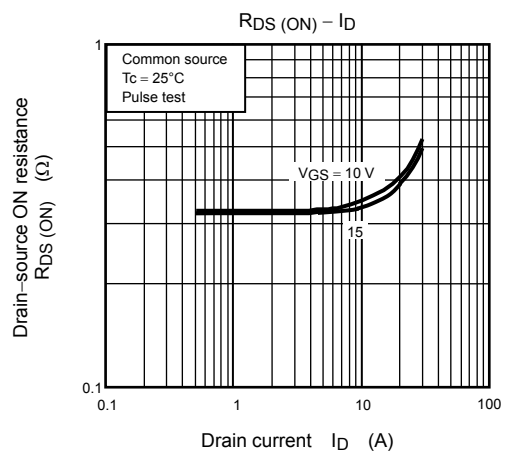
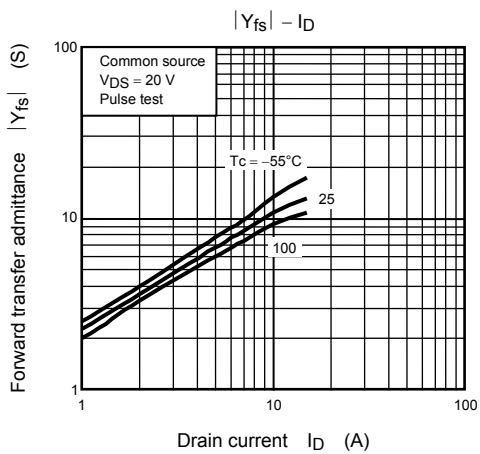
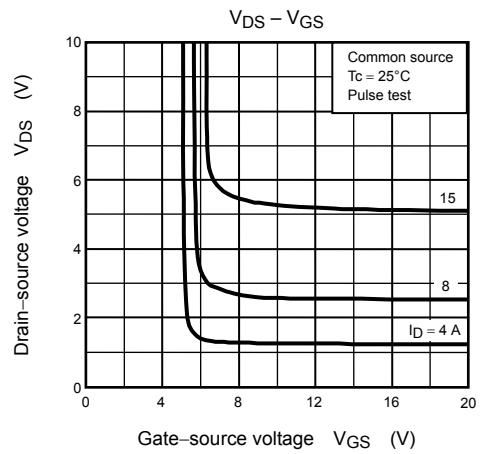
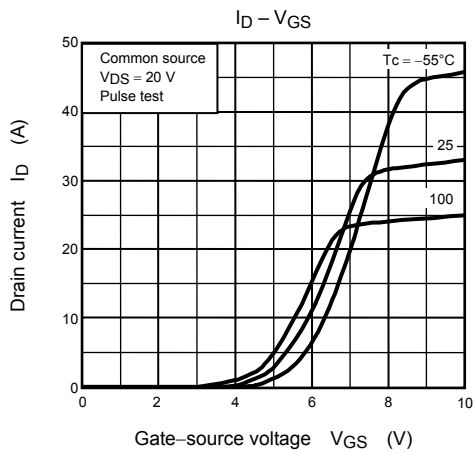
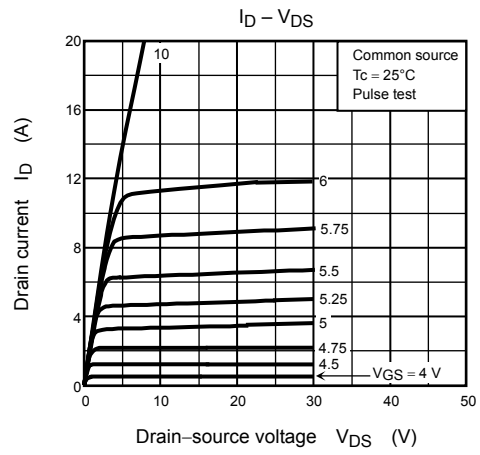
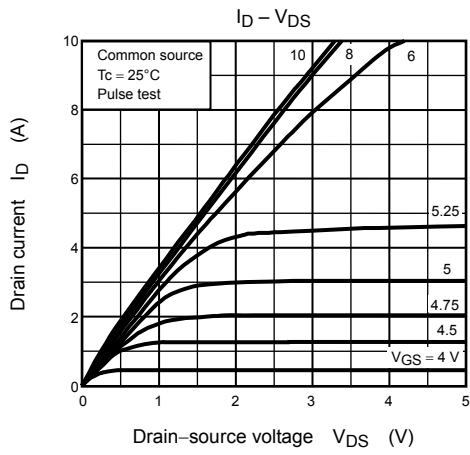
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	0.833	$^{\circ}\text{C}/\text{W}$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	50	$^{\circ}\text{C}/\text{W}$

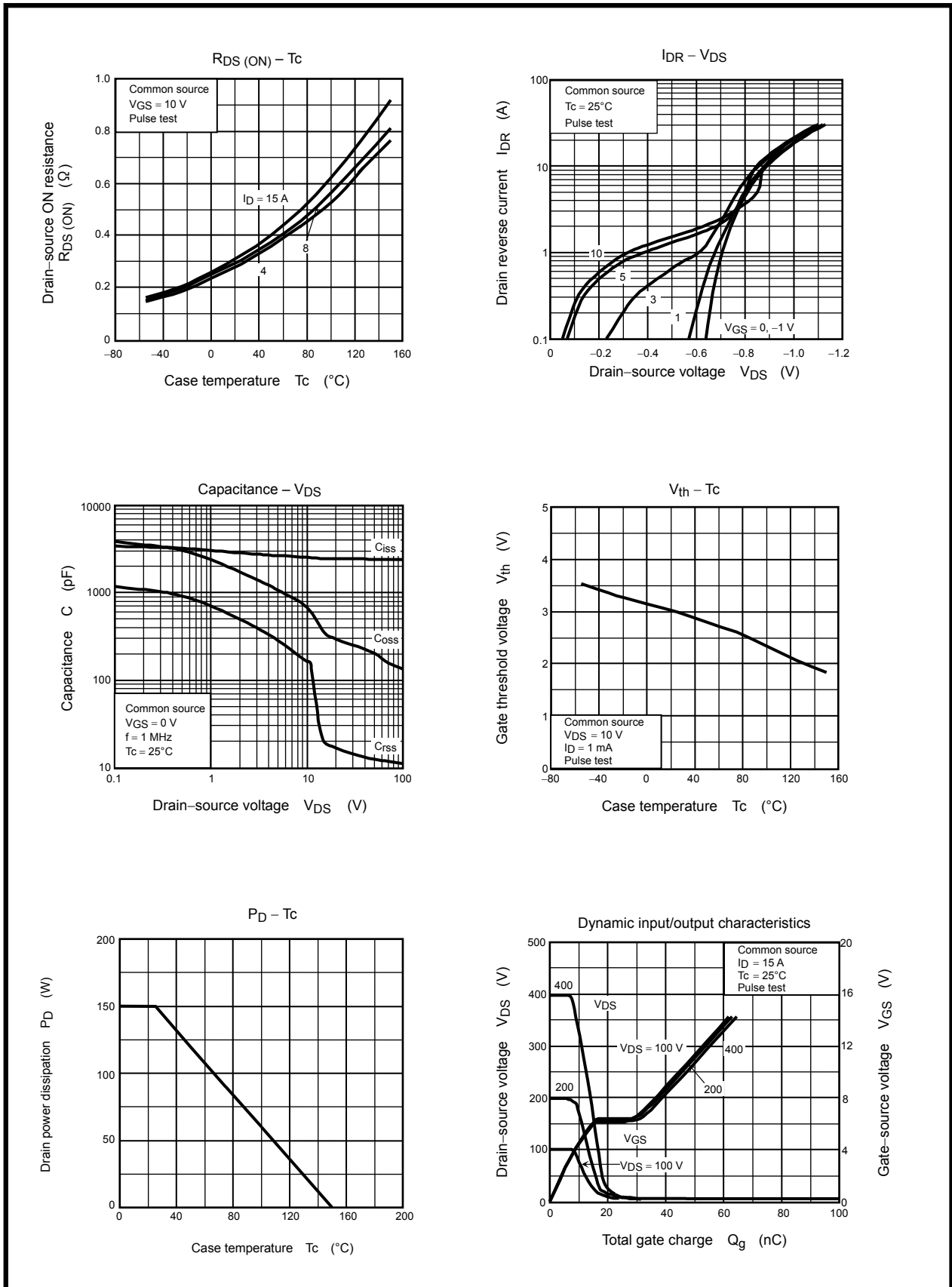
Note 1: Ensure that the channel temperature does not exceed 150°C.

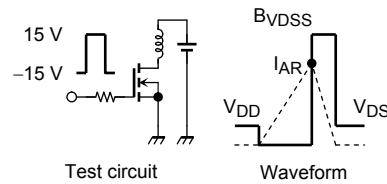
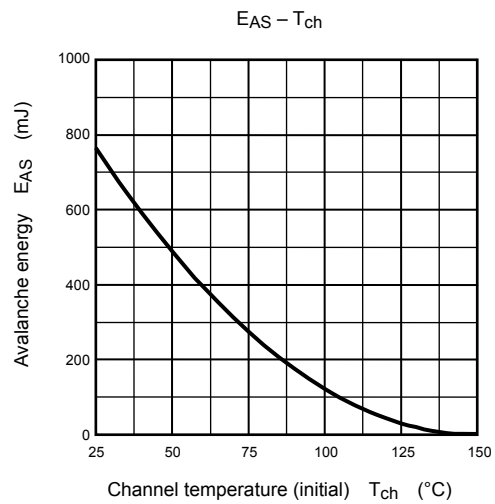
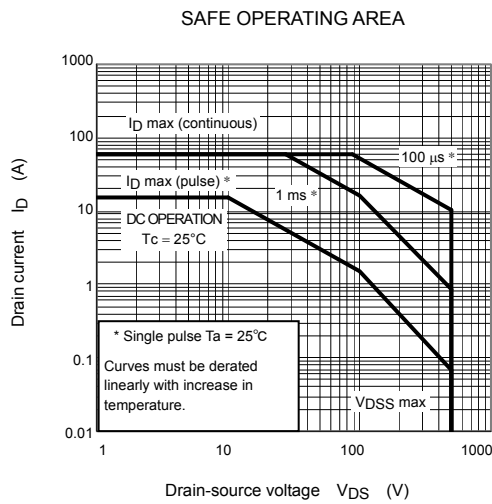
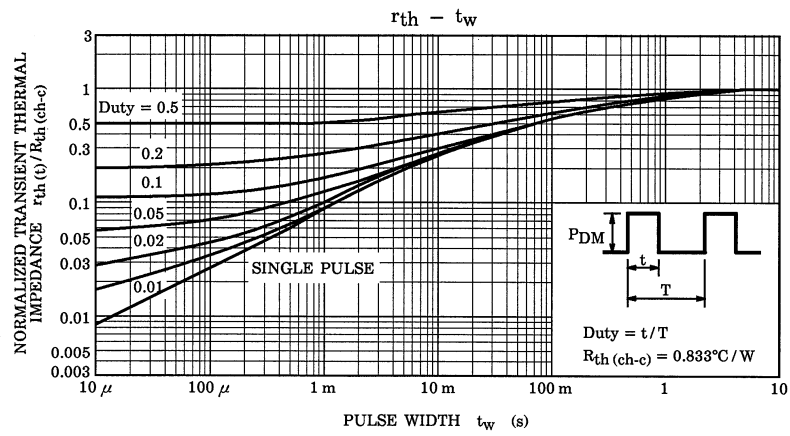
Note 2: $V_{DD} = 90\text{ V}, T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 5.78\text{ mH}, R_G = 25\ \Omega, I_{AR} = 15\text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.





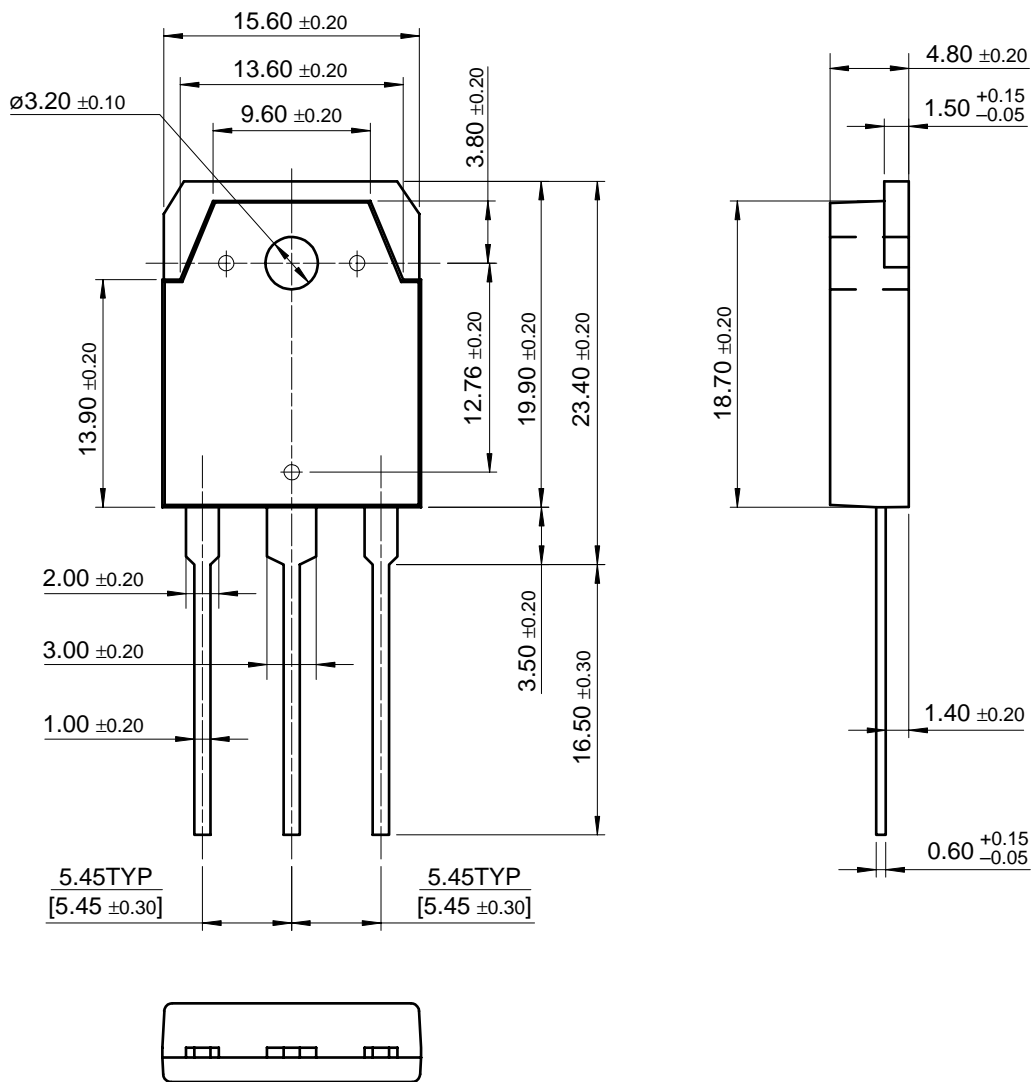


$R_G = 25 \Omega$
 $V_{DD} = 90 \text{ V}, L = 5.78 \text{ mH}$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left(\frac{B_{V_{DSS}}}{B_{V_{DSS}} - V_{DD}} \right)$$

THINKI TO-3P Package Dimensions

TO-3PN-SQ/TO-3PB-SQ



Dimensions in Millimeters